

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
Patent Application

Inventor(s): Massimo CIVILINI Group Art Unit:
 Filed: 6/24/03 Examiner:
 Serial No.:
 Title: AN ELECTRONIC COMPONENT RELIABILITY DETERMINATION SYSTEM AND METHOD

Form 1449**U.S. Patent Documents**

Examiner Initial	No.	Patent No.	Date	Patentee	Class	Sub-class	Filing Date
A							
B							
C							
D							
E							
F							
G							
H							
I							
J							
K							

Foreign Patent or Published Foreign Patent Application

Examiner Initial	No.	Document No.	Publication Date	Country or Patent Office	Class	Sub-class	Translation
							Yes No
L							
M							
N							
O							
P							
Q							

Other Documents

Examiner Initial	No.	Author, Title, Date, Place (e.g. Journal) of Publication
SUS	R	"SRAM Module; Mean Time Between Failure Analysis (MTBF)," Hybrid Memory Products LTD, February 1999, 11 pages
SUS	S	"Reliability Prediction of Board-Mounted Power Modules," Tyco Electronics, Technical Note, July 1997, 6 pages
	T	

Examiner *[Signature]* Date Considered 4/20/06

Examiner. Initial citation considered. Draw line through citation if not in conformance and not considered.
 Include copy of this form with next communication to applicant.

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The Commissioner of Patents and Trademarks
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Information Disclosure Statement Submitted Pursuant to 37 C.F.R. 1.97(b)

The citations referenced herein, copies attached, may be material to the examination of the above-identified application and are, therefore, submitted in compliance with the duty of disclosure as defined in 37 C.F.R. 1.56. The Examiner is requested to make these citations of official record in the application.

This Information Disclosure Statement submitted in accordance with 37 C.F.R. 1.97(b) is not to be construed as a representation that a search has been made, that additional items material to the examination of this application do not exist, or that any one or more of these citations constitute prior art under 35 U.S.C. 102.

The Examiner's attention is respectfully directed to the following documents:

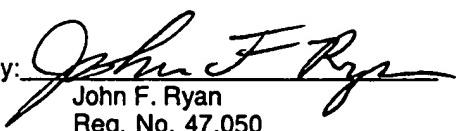
<u>Title</u>	<u>Publication Date</u>
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Respectfully submitted,

Date: 6/24/03

By: 
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